

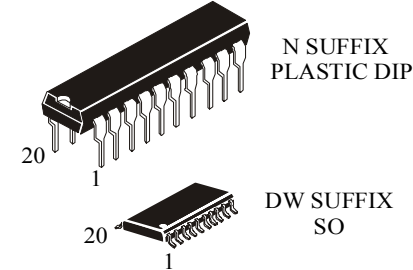
Octal D Flip-Flop with Common Clock and Reset

IN74LV273

The IN74LV273 is a low-voltage Si-gate CMOS device and is pin and function compatible with the 74HC/HCT273.

The IN74LV273 has eight edge-triggered, D-type flip-flops with individual D inputs and Q outputs. The common clock (CP) and master reset (MR) inputs load and reset (clear) all flip-flops simultaneously. The state of each D input, one set-up time before the LOW-to-HIGH clock transition, is transferred to the corresponding output (Qn) of the flip-flop. All outputs will be forced LOW independently of clock or data inputs by a LOW voltage level on the MR input. The device is useful for applications where the true output only is required and the clock and master reset are common to all storage elements.

- Output voltage levels are compatible with input levels of CMOS, NMOS and TTL ICs
- Supply voltage range: 1.2 to 5.5 V
- Low input current: 1.0 μA; 0.1 μA at T = 25 °C
- High Noise Immunity Characteristic of CMOS Devices

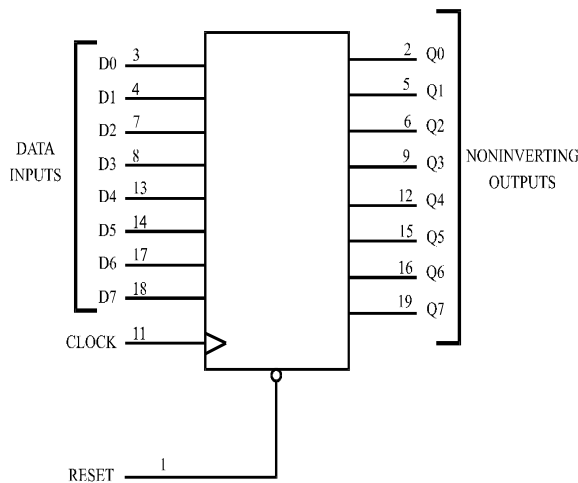


ORDERING INFORMATION

IN74LV273N Plastic DIP
IN74LV273DW SOIC

T_A = -40° to 125° C for all packages

LOGIC DIAGRAM



PIN 20 = V_{CC}
 PIN 10 = GND

PIN ASSIGNMENT

RESET	1	20	V _{CC}
Q0	2	19	Q7
D0	3	18	D7
D1	4	17	D6
Q1	5	16	Q6
Q2	6	15	Q5
D2	7	14	D5
D3	8	13	D4
Q3	9	12	Q4
GND	10	11	CLOCK

FUNCTION TABLE

Inputs			Output
Reset	Clock	D	Q
L	X	X	L
H		H	H
H		L	L
H	L	X	no change
H		X	no change

H= high level
 L = low level
 X = don't care
 Z = high impedance

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	DC supply voltage	-0.5 to +7.0	V
I _{IK} * ¹	Input diode current	±20	mA
I _{OK} * ²	Output diode current	±50	mA
I _O * ³	Output source or sink current	±25	mA
I _{CC}	V _{CC} current	±50	mA
I _{GND}	GND current	±50	mA
P _D	Power dissipation per package: Plastic DIP * ⁴ SO * ⁴	750 500	mW
T _{stg}	Storage Temperature	-65 to +150	°C
T _L	Lead Temperature, 1.5 mm (Plastic DIP Package), 0.3 mm (SO Package) from Case for 4 Seconds	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

*¹ V_I < -0.5 V or V_I > V_{CC} + 0.5 V.

*² V_O < -0.5 V or V_O > V_{CC} + 0.5 V.

*³ -0.5 V < V_O < V_{CC} + 0.5 V.

*⁴ Derating - Plastic DIP: - 12 mW/°C from 70° to 125°C
SO Package: - 8 mW/°C from 70° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	1.2	5.5	V
V _I	DC Input Voltage	0	V _{CC}	V
V _O	DC Output Voltage	0	V _{CC}	V
T _A	Operating Temperature, All Package Types	-40	+125	°C
t _r , t _f	Input Rise and Fall Time (Figure 1)			ns
	0 V ≤ V _{CC} ≤ 2.0 V	0	500	
	2.0 V ≤ V _{CC} ≤ 2.7 V	0	200	
	2.7 V ≤ V _{CC} ≤ 3.6 V	0	100	
	3.6 V ≤ V _{CC} ≤ 5.5 V	0	50	

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range GND ≤ (V_{IN} or V_{OUT}) ≤ V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

Symbol	Parameter	Test conditions	V _{CC} V	Guaranteed Limit								Unit
				25°C		-40°C		85°C		125°C		
				min	max	min	max	min	max	min	max	
V _{IH}	HIGH level input voltage		1.2	0.9	-	0.9	-	0.9	-	0.9	-	V
			2.0	1.4	-	1.4	-	1.4	-	1.4	-	
			2.7	2.0	-	2.0	-	2.0	-	2.0	-	
			3.0	2.0	-	2.0	-	2.0	-	2.0	-	
			3.6	2.0	-	2.0	-	2.0	-	2.0	-	
			4.5	3.15	-	3.15	-	3.15	-	3.15	-	
			5.5	3.85	-	3.85	-	3.85	-	3.85	-	
V _{IL}	LOW level output voltage		1.2	-	0.3	-	0.3	-	0.3	-	0.3	V
			2.0	-	0.6	-	0.6	-	0.6	-	0.6	
			2.7	-	0.8	-	0.8	-	0.8	-	0.8	
			3.0	-	0.8	-	0.8	-	0.8	-	0.8	
			3.6	-	0.8	-	0.8	-	0.8	-	0.8	
			4.5	-	1.35	-	1.35	-	1.35	-	1.35	
			5.5	-	1.65	-	1.65	-	1.65	-	1.65	
V _{OH}	HIGH level output voltage	V _I = V _{IH} or V _{IL} I _O = -100 μA	1.2	1.05	-	1.05	-	1.0	-	1.0	-	V
			2.0	1.85	-	1.85	-	1.8	-	1.8	-	
			2.7	2.55	-	2.55	-	2.5	-	2.5	-	
			3.0	2.85	-	2.85	-	2.8	-	2.8	-	
			3.6	3.45	-	3.45	-	3.4	-	3.4	-	
			4.5	4.35	-	4.35	-	4.3	-	4.3	-	
			5.5	5.35	-	5.35	-	5.3	-	5.3	-	
V _{OH}	HIGH level output voltage	V _I = V _{IH} or V _{IL} I _O = -6 mA	3.0	2.48	-	2.48	-	2.40	-	2.20	-	V
		V _I = V _{IH} or V _{IL} I _O = -12 mA	4.5	3.70	-	3.70	-	3.60	-	3.50	-	V
V _{OL}	LOW level output voltage	V _I = V _{IH} or V _{IL} I _O = 100 μA	1.2	-	0.15	-	0.15	-	0.2	-	0.2	V
			2.0	-	0.15	-	0.15	-	0.2	-	0.2	
			2.7	-	0.15	-	0.15	-	0.2	-	0.2	
			3.0	-	0.15	-	0.15	-	0.2	-	0.2	
			3.6	-	0.15	-	0.15	-	0.2	-	0.2	
			4.5	-	0.15	-	0.15	-	0.2	-	0.2	
			5.5	-	0.15	-	0.15	-	0.2	-	0.2	
V _{OL}	LOW level output voltage	V _I = V _{IH} or V _{IL} I _O = 6 mA	3.0	-	0.33	-	0.33	-	0.40	-	0.50	V
		V _I = V _{IH} or V _{IL} I _O = 12 mA	4.5	-	0.40	-	0.40	-	0.55	-	0.65	V
I _I	Input current	V _I = V _{CC} or 0 V	5.5	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	Supply current	V _I = V _{CC} or 0 V I _O = 0 μA	5.5	-	8.0	-	8.0	-	80	-	160	μA
I _{CC1}	Additional supply current per input	V _I = V _{CC} - 0.6V	2.7 3.6	-	0.2	-	0.2	-	0.5		0.85	mA

AC ELECTRICAL CHARACTERISTICS (CL=50 pF, tr=tf=2.5 ns)

Symbol	Parameter	Test conditions	V _{CC} V	Guaranteed Limit						Unit
				-40°C to 25°C		85°C		125°C		
				min	max	min	max	min	max	
t _{PHL} , t _{PLH}	Propagation delay, Clock to Q	V _I = 0 V or V _I Figures 1,4	1.2	-	150	-	150	-	150	ns
			2.0	-	30	-	32	-	41	
			2.7	-	22	-	24	-	30	
			3.0	-	17	-	19	-	24	
			4.5	-	14	-	16	-	20	
t _{PHL}	Propagation delay, Reset to Q	V _I = 0 V or V _I Figures 2,4	1.2	-	160	-	160	-	160	ns
			2.0	-	40	-	44	-	56	
			2.7	-	30	-	33	-	41	
			3.0	-	23	-	26	-	33	
			4.5	-	19	-	22	-	28	
C _I	Input capacitance		5.0	-	6.0*	-	-	-	-	pF
C _{PD}	Power dissipation capacitance (per flip-flop)	V _I = 0 V or V _{CC}	5.5	-	40*	-	-	-	-	pF

* T = 25°C

TIMING REQUIREMENTS(CL=50 pF, tr=tf=2.5 ns)

Symbol	Parameter	Test conditions	V _{CC} V	Guaranteed Limit						Unit
				-40°C to 25°C		85°C		125°C		
				min	max	min	max	min	max	
t _w	Pulse Width, Clock (low or high), Reset (low)	V _I = 0 V or V _I Figures 1,2,4	1.2	60	-	70	-	80	-	ns
			2.0	28	-	34	-	41	-	
			2.7	21	-	25	-	30	-	
			3.0	16	-	20	-	24	-	
			4.5	12	-	16	-	20	-	
t _{su}	Setup Time, Data to Clock	V _I = 0 V or V _I Figures 3,4	1.2	40	-	50	-	60	-	ns
			2.0	18	-	22	-	26	-	
			2.7	13	-	16	-	19	-	
			3.0	11	-	13	-	15	-	
			4.5	9	-	11	-	13	-	
t _{rem}	Removal Time, Reset to Clock	V _I = 0 V or V _I Figures 2,4	1.2	5	-	5	-	5	-	ns
			2.0	5	-	5	-	5	-	
			2.7	5	-	5	-	5	-	
			3.0	5	-	5	-	5	-	
			4.5	5	-	5	-	5	-	
t _h	Hold Time, Clock to Data	V _I = 0 V or V _I Figures 3,4	1.2	50	-	50	-	50	-	ns
			2.0	5	-	5	-	5	-	
			2.7	5	-	5	-	5	-	
			3.0	5	-	5	-	5	-	
			4.5	5	-	5	-	5	-	
f _c	Clock Frequency	V _I = 0 V or V _I Figures 1,4	1.2	-	2	-	1	-	1	MHz
			2.0	-	17	-	14	-	12	
			2.7	-	23	-	19	-	16	
			3.0	-	30	-	24	-	20	
			4.5	-	32	-	27	-	24	

V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

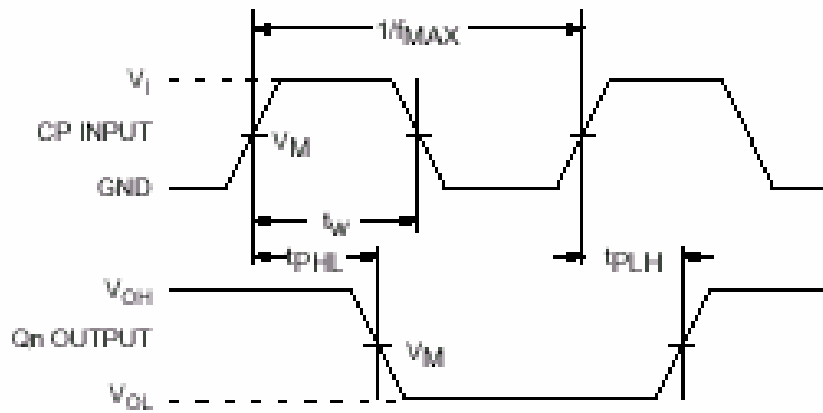


Figure 1. Switching Waveforms

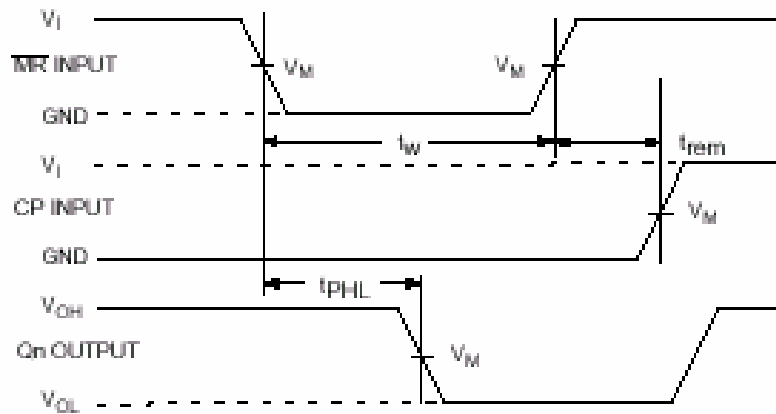


Figure 2. Switching Waveforms

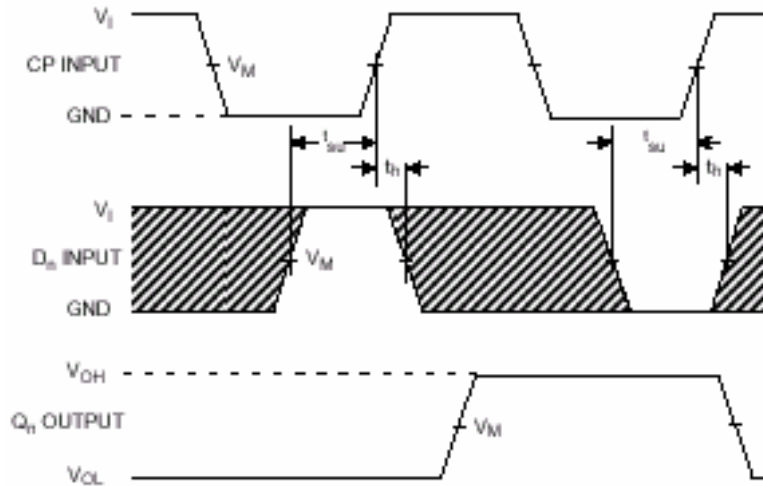
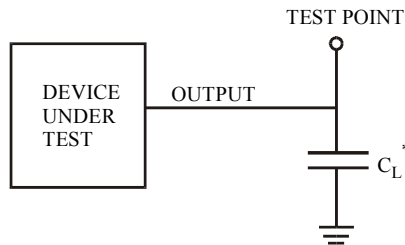


Figure 3. Switching Waveforms

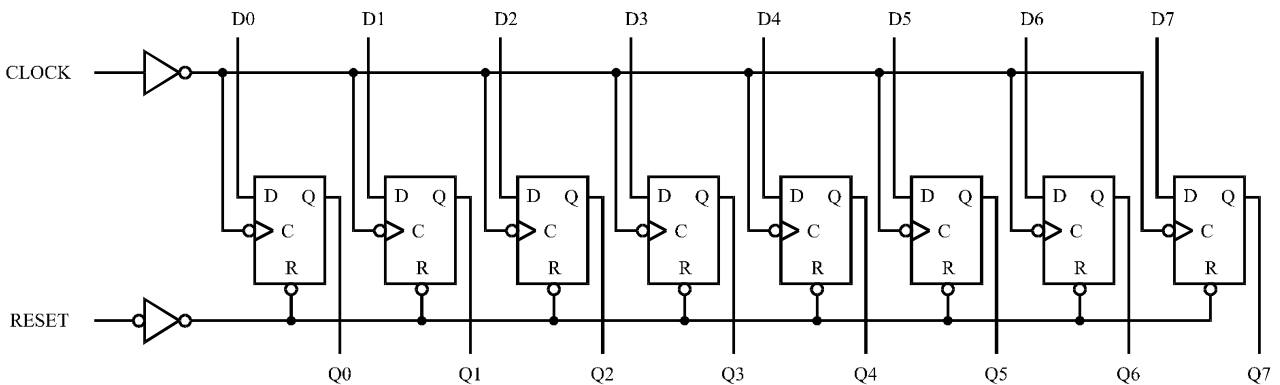
Symbol	Level of a signal, V				
V _{CC}	1,2	2,0	2,7	3,0	4,5
V _I	1,2	2,0	2,7	2,7	4,5
V _M	0,6	1,0	1,5	1,5	2,25



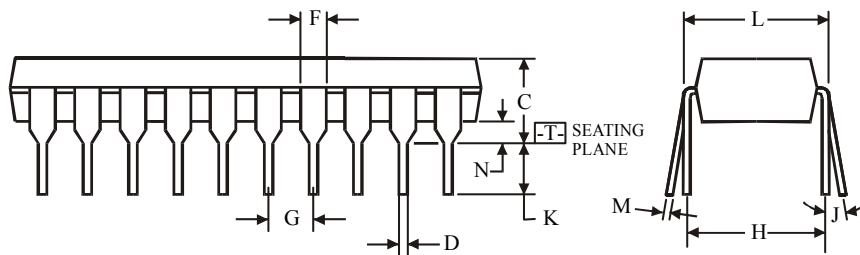
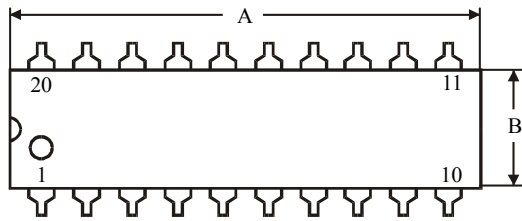
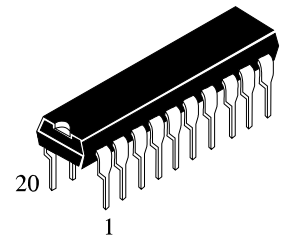
* Includes all probe and jig capacitance

Figure 4. Test Circuit

EXPANDED LOGIC DIAGRAM



**N SUFFIX PLASTIC DIP
(MS - 001AD)**



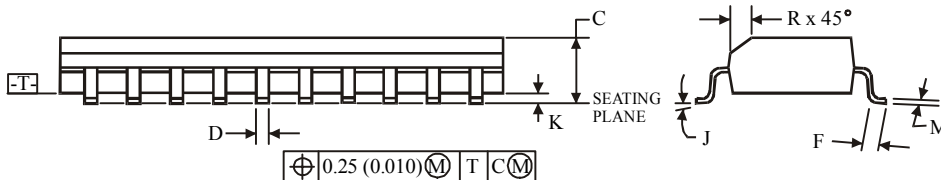
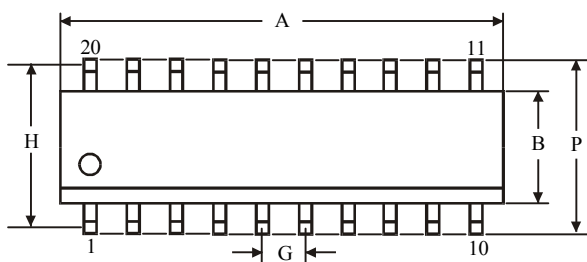
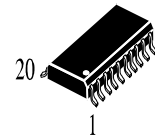
$\oplus 0.25 (0.010) \text{M} \text{T}$

NOTES:

- Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	24.89	26.92
B	6.1	7.11
C		5.33
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

**D SUFFIX SOIC
(MS - 013AC)**



$\oplus 0.25 (0.010) \text{M} \text{T} \text{C} \text{M}$

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	12.6	13
B	7.4	7.6
C	2.35	2.65
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	9.53	
J	0°	8°
K	0.1	0.3
M	0.23	0.32
P	10	10.65
R	0.25	0.75